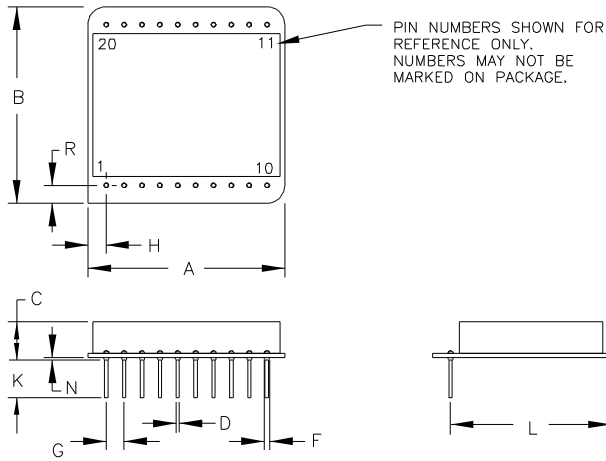


Package Number 102 - 20-Lead ISO Omni



DIM	INCHES		MILLIMETERS		NOTE	DIM	INCHES		MILLIMETERS		NOTE
	MIN.	MAX.	MIN.	MAX.			MIN.	MAX.	MIN.	MAX.	
A	1.080	1.120	27.43	28.45							
B	1.080	1.120	27.43	28.45							
C	.235	.285	5.97	7.24							
D	.018	.021	0.46	0.53							
F	.035	.050	0.89	1.27							
G	.100	BASIC	2.54	BASIC							
H	.100	BASIC	2.54	BASIC							
K	.150	.350	3.81	8.89							
L	.900	BASIC	22.86	BASIC							
N	.002	.010	0.05	0.25							
R	.100	BASIC	2.54	BASIC							

NOTES:
 1. LEADS IN TRUE POSITION WITHIN .010" (.25mm) R @ MMC AT SEATING PLANE.

PACKAGE NUMBER: ZZ102 REV.: A
 JEDEC NUMBER: NONE



PACKAGE DRAWING

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